

Huntington Beach, CA, USA - 12 January 2017

Name	Employer	Affiliation
Anslow, Peter	Ciena Corporation	Ciena Corporation
Baldwin, Thananya	Ixia	Ixia
Beaulieu, Tim		UNH-IOL
Beia, Christian	STMicroelectronics	STMicroelectronics
Brandt, David	Rockwell Automation	Rockwell Automation
Braun, Ralf-Peter	Deutsche Telekom AG	Deutsche Telekom AG
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions
Brown, Alan M	ADTRAN Inc.	ADTRAN Inc.
Brown, Matthew	Applied Micro (AMCC)	Applied Micro (AMCC)
Brownlee, Phillip	TDK Corporation	TDK Corporation
Butter, Adrian	GLOBALFOUNDRIES	GLOBALFOUNDRIES
Carlson, Steven	High-Speed Design Inc.	Robert Bosch GmbH
Chabot, Craig	University of New Hampshire InterOperability Laboratory (UNH-	University of New Hampshire InterOperability Laboratory (UNH-
Chadha, Mandeep	Microsemi Corporation	Microsemi Corporation
Chang, Yongmao	Inphi Corporation	Inphi Corporation
Coppinger, Fred		Samtec, Inc.
D'Ambrosia, John	Futurewei Technologies	Futurewei (Subsidiary of Huawei)
Dawe, Piers J G	Mellanox Technologies	Mellanox Technologies
DiBiaso, Eric	TE Connectivity	TE Connectivity
Diminico, Christopher	M C Communications, LLC	Panduit Corp.
Donahue, Curtis	University of New Hampshire InterOperability Laboratory (UNH- IOL)	UNH-IOL
Dudek, Michael	Cavium	Cavium
Effenberger, Frank	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Estes, David	Spirent Communications	Spirent Communications
Ewen, John	GLOBALFOUNDRIES	GLOBALFOUNDRIES
Fritsche, Matthias	HARTING Technologie Gruppe	HARTING Electronics GmbH
Gardner, Mike	Molex Incorporated	Molex Incorporated
Goergen, Joel	Cisco Systems, Inc.	Cisco Systems, Inc.
Goldberg, Jonathan	IEEE Standards Association (IEEE- SA)	IEEE STAFF
Gorshe, Steven Scott	Microsemi Corporation	Microsemi Corporation
Gottron, Jens	Siemens AG	Siemens AG
Grau, Olaf	Robert Bosch GmbH	Robert Bosch GmbH
Grow, Robert	RMG Consulting	RMG Consulting, KDPOF
Gustlin, Mark	Xilinx	Xilinx
Hajduczenia, Marek	Charter Communications	Charter Communications
Hayakawa, Akinori	FUJITSU LABORATORIES LIMITED	FUJITSU LABORATORIES LIMITED
Healey, Adam	Broadcom Ltd.	Broadcom Ltd.

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Heck, Howard		Intel Corporation
Hidaka, Yasuo	Fujitsu Laboratories of America, Inc.	Fujitsu Laboratories of America, Inc.
HYAKUTAKE, YASUHIRO	Adamant Co., Ltd.	Adamant Co., Ltd.
Ingham, Jonathan	Foxconn Interconnect Technology	Foxconn Interconnect Technology
Jackson, Kenneth	Sumitomo Electric Device Innovations, USA	Sumitomo Electric Industries, LTD
Johnson, John	Broadcom Limited	Broadcom Limited
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.
Kimber, Eric	Semtech Ltd	Semtech Ltd
Klempa, Michael	University of New Hampshire InterOperability Laboratory (UNH-IOL)	University of New Hampshire InterOperability Laboratory (UNH-IOL)
Kramer, Glen	Broadcom Corporation	Broadcom Corporation
Lapak, Jeffrey	University of New Hampshire InterOperability Laboratory (UNH-IOL)	University of New Hampshire InterOperability Laboratory (UNH-IOL)
Laubach, Mark	Broadcom Limited	Broadcom Corporation
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Leung, Michael	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Lewis, David	Lumentum Inc.	Lumentum Inc.
Lewis, Jon	Dell	Dell
Lin, Alex	MediaTek	MediaTek Inc.
liu, dekun		Huawei Technologies Co. Ltd
Madgar, Zahy	Valens Semiconductor	Valens Semiconductor
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.
Malicoat, David	Malicoat Networking Solutions	Kazan Networks
MALKIMAN, YONATAN	Mellanox Technologies	Mellanox Technologies
Mcclellan, Brett	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.
Moffitt, Bryan	CommScope	CommScope, Inc.
Nemr, Daniel	University of New Hampshire InterOperability Laboratory (UNH-IOL)	University of New Hampshire InterOperability Laboratory (UNH-IOL)
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.
O'Neil, Adam	University of New Hampshire InterOperability Laboratory (UNH-IOL)	University of New Hampshire InterOperability Laboratory (UNH-IOL)
Palkert, Thomas	EIC	Molex-MoSys

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Pandey, Sujan	NXP Semiconductors	NXP Semiconductors
Pardo, Carlos	Knowledge Development for POF SL	KDPOF
Pepper, Gerald	Ixia	Ixia
Powell, William	Nokia	Nokia
Rabinovich, Rick	Ixia	Ixia
RAN, ADEE	Intel Corporation	Intel Corporation
Regev, Alon	Ixia	Ixia
Remein, Duane	Futurewei Technologies	Huawei Technologies Co. Ltd
Sakai, Toshiaki	socionext	socionext
Shariff, Masood	CommScope, Inc.	CommScope, Inc.
Shrikhande, Kapil	Innovium Inc.	Innovium
sisk, jason		University of New Hampshire InterOperability Laboratory (UNH- IOL)
Smith, Daniel	Seagate Technology LLC	Seagate Technology LLC
Sommers, Scott	Molex Incorporated	Molex Incorporated
Sone, Yoshiaki	NTT	Nippon Telegraph and Telephone Corporation (NTT)
Sparrowhawk, Bryan	Leviton Manufacturing Co.	Leviton Manufacturing Co.
Squiers, Ronald	Mentor Graphics	Mentor Graphics; Siemens USA
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Stewart, Heath	Linear Technology	Linear Technology
Stover, David	Linear Technology	Linear Technology
Su, Ching-Yao	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.
Suzuki, Ken-Ichi	Nippon Telegraph and Telephone Corporation (NTT)	NTT
Tailor, Bharat	Semtech Canada Corporation	Semtech Canada Corporation
Tamura, Kohichi	Oclaro Japan Inc.	Oclaro Japan Inc.
Thaler, Patricia	Broadcom Limited	Broadcom Corporation
Thompson, Geoffrey	GraCaSI S.A.	INDEPENDENT
Tracy, Nathan	TE Connectivity	TE Connectivity
Trowbridge, Stephen	Nokia	Nokia
Ulrichs, Ed	Source Photonics	Source Photonics
Umnov, Alexander	Corning Incorporated	Corning Incorporated
Vanderlaan, Paul	Berk-Tek LLC	Berk-Tek LLC
wang, haifei	Huawei Technologies Co. Ltd	Huawei Technologies Co., Ltd
Wang, Xinyuan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Wendt, Matthias	Philips Lighting	Philips Lighting
Wertheim, Oded	Mellanox Technologies	Mellanox Technologies
Wey, Jun Shan	ZTE Corporation	ZTE Corporation
Wienckowski, Natalie	General Motors Company	General Motors Company

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Winkel, Ludwig	Siemens AG	Siemens AG
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Yoo, Sungjong	Molex Incorporated	Molex Incorporated
Young, Adrian	Leviton Manufacturing Co.	Leviton Manufacturing Co.
Yseboodt, Lennart	Philips Electronics	Philips Electronics
ZHAO, Dianbo		Huawei Technologies Co. Ltd
Zhuang, Yan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Zimmerman, George	CME Consulting	ADI, Aquantia, CommScope, Inc., Linear Technology, and Cisco Systems
Zinner, Helge	Continental Automotive Systems AG	Continental Automotive Systems AG
Zivny, Pavel	Tektronix, Inc.	Tektronix, Inc.